AP	PLICA	BLE STA	NDARD									
		Operating Temperature Range Voltage		-55°C to 125°C(Notes 1) 30V AC/DC		Temp	Storage Temperature Rai		-10°C TO 60°C			
R	ATING					Mating Conne			DF40TC-30DP-0. 4V			
		Current		0. 3A								
	SPECIFICATIONS											
		EM		TEST METHOD				REQI	JIREMENTS	QT	AT	
		UCTION										
	General Examination			Visually and by measuring instrument.			 According to dra 		awing.	X	X	
				Confirmed visually.			<u> </u>			Х	Х	
	ELECTRIC CHARA										1	
			20mV AC	20mV AC or less 1khz, 1mA.			1 90	X –				
Insu	nsulation Resistance		100V DC	100V DC.			1 50	^{0MΩ MIN.}			_	
Volt	Voltage Proof		100V AC	100V AC for 1 min.			1) N	o flashover oi	Х	_		
ME	ECHAN	ICAL CH	IARACTE	RACTERISTICS								
Med	Mechanical Operation		10times i	10times insertions and extractions.			<u> </u>	ontact resistance: $90m\Omega$ MAX. o damage, crack or looseness of parts. X				
	Vibration		Sweep tir 8h for 3 a	Frequency 10 to 500, acceleration 49 m/s ^{2.,} Sweep time 1 oct/min. 8h for 3 axial directions.					continuity of 1 μs.	х	_	
	Shock		at 3 times	Acceleration 980 m/s ² , duration of pulse 6 ms at 3 times for 3 directions.			② No damage, crack or looseness of parts.				_	
				ACTERISTICS							1	
	Rapid Change of Temperature			Temperature -55 \rightarrow 125 °C Time 30 \rightarrow 30 min Under 1000 cycles. Exposed at 125 °C, 1,000 h.			1) C	Contact resistance: 90mΩ MAX.		х	-	
ע ^{Dry}	Dry Heat						No damage, crack or looseness of parts.				_	
λ Dar	Damp Heat			Exposed at 60 \pm 2 °C Relative humidity 90 to 95 %, 1000 h.			 Contact resistance: 90mΩ MAX. 				_	
∆ ^{Dar}	Damp Heat, Cyclic			Exposed at -10 to 65°C, Relative humidity 90 to 96%, 10cycles, total 240h.			 ② Insulation resistance: 25 MΩ MIN. ③ No damage, crack or looseness of parts. 			x . x	_	
7 _{Sni}	Sulphur Dioxide			Exposed in 25 PPM for 96h, 40°C, Relative humidity 80%.			① Contact resistance: 180mΩ MAX. X			x	_	
	Heat Resistance of Soldering			Recommended temperature profile soldering area MAX 250°C, 220°C for 60 seconds MAX. Preheating area 150 to 180°C 90 to 120 seconds. Maximum twice action is allowed under the same condition. Recommended manual soldering condition Soldering iron temperature 350°C. Soldering time: within 3 seconds.			 No deformation of case of excessive looseness of the terminals. X – 				_	
Solo	Solderability			Soldering temperature: $245 \pm 5^{\circ}$ C Duration of immersion: soldering for 3 ± 0.5 seconds.			A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.					
	COUN	Т	DESCRIPTIO	ON OF REVISIONS		DESIG	NED		CHECKED	DA	TE	
	7		DIS-	H-00009674		YK. SAT	AKE		TS. MIYAZAKI	2021	0623	
	MARKS e1: Include	the temperatu	ure rising by cu	rising by current				APPROVED		_	0402	
			0,					CHECKED	TS. MIYAZAKI		0402	
								DESIGNED	YK. SATAKE		0402	
Unless otherwise specified, refer to JIS C 5402. IEC 60512. Note QT:Qualification Test AT:Assurance Test X:Applicable Test						DRAWING NO.			YK. SATAKE 2021040 ELC-381845-58-00			
	SPECIFICATION SHEET					PART			TC (3. 0) -30DS-0. 4V (58)			
			ROSE EI	OSE ELECTRIC CO., LTD.			NO.	CL0684-4242-0-58		⚠	1/1	